

Power & Reset

The OSD335x-SM contains 4.7k pull-up resistors on I2C0. External resistors added so that pull-up strength can be changed due to layout or other requirements.

TPS65217 I2C Address: 0x24
EEPROM I2C Address: 0x50
AT97SC3205T I2C Address: 0x29

Reset supervisor circuit:
Reset asserted if VCC drops below V threshold,
push button or POR.
De-asserted after 240ms

To Print: Use 8.5"x11"
paper in landscape;
0.69 scaling factor.

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This is a clamping circuit between the VDDS and VDDSHV inputs of the AM335x inside the OSD335x-SM. The clamping circuit is related to power down issues (see <https://octavosystems.com/osd335x/clamping/> for more information). This may not be needed in your application if the power down conditions do not apply to your application.

Reset inputs:

- Manual push-button
- PMIC_PGOOD

Reset supervisor MR# has internal pull up to SYS_VDD1_3P3V. Each reset input is effectively open drain and can only pull reset line low. Resistors added only for debug and are not necessary.

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The OSD335x-SM contains 4.7k pull-up resistors on I2C0. External resistors added so that pull-up strength can be changed due to layout or other requirements.

TPS65217 I2C Address: 0x24
EEPROM I2C Address: 0x50
AT97SC3205T I2C Address: 0x29

This is a clamping circuit between the VDD5 and VDDSHV inputs of the AM335x inside the OSD335x-SM. The clamping circuit is related to power down issues (see <https://octavosystems.com/osd335x/clamping/> for more information). This may not be needed in your application if the power down conditions do not apply to your application.

Reset inputs:

- 1) Manual push-button
- 2) PMIC_PGOOD

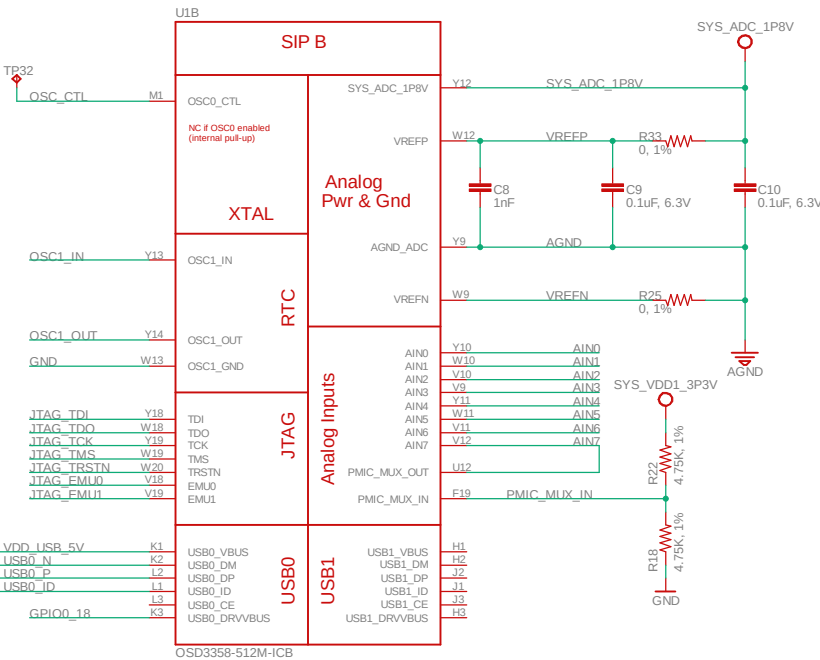
Reset supervisor MR# has internal pull up to SYS_VDD1_3P3V. Each reset input is effectively open drain and can only pull reset line low. Resistors added only for debug and are not necessary.

To Print: Use 8.5"x11"
paper in landscape;
0.69 scaling factor.

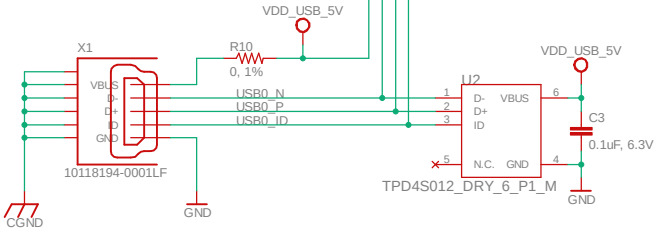
Clocks, Analog & USB

The values for C7 and C12 can be calculated using information in FAQ: <https://octavosystems.com/faq/design-oscillator-circuit-osd335x-family-devices/#more-3862>

Clock resistors R32 and R24 may not be needed in your design. See <https://octavosystems.com/osd335x/clock/> for more information.



The 0 Ohm resistor (R10) on the VBUS input can be replaced with a ferrite bead for noise suppression or a solder bridge for cost reduction.



USB Client

If the analog interface is not used, then VREFP and VREFN should be shorted to AGND.

SYS_ADC_1P8V and AGND_ADC are connected to SYS_VDD_1P8V and DGND, respectively, through ferrite beads inside the SIP. It is not necessary to connect these rails to anything else. However, bypass capacitors should be added to reduce noise, if needed for your application.

Maximum voltage for the analog inputs is 1.8V.

AIN7 currently monitors the PMIC voltages via the internal PMIC mux. See the 'Analog Multiplexer' section of the TPS65217 datasheet. For the internal PMIC voltages, there are dividers within the PMIC to keep the monitored voltages under 1.8V. However, PMIC_MUX_IN does not have any dividers and must be less than 1.8V. By default, PMIC_MUX_OUT is Hi-Z. The MUXCTRL register in the PMIC is used to select the PMIC_MUX_OUT voltage path.

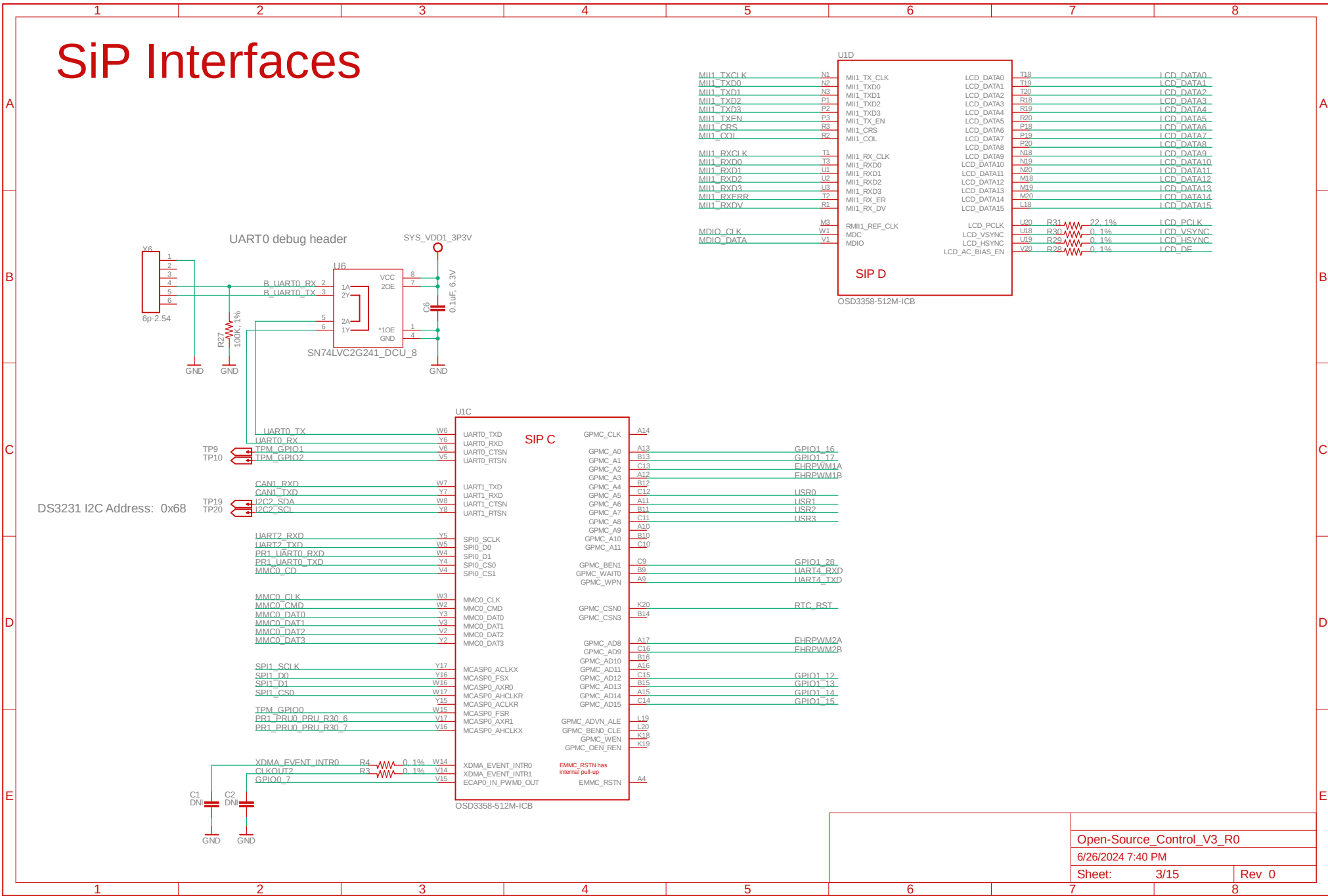
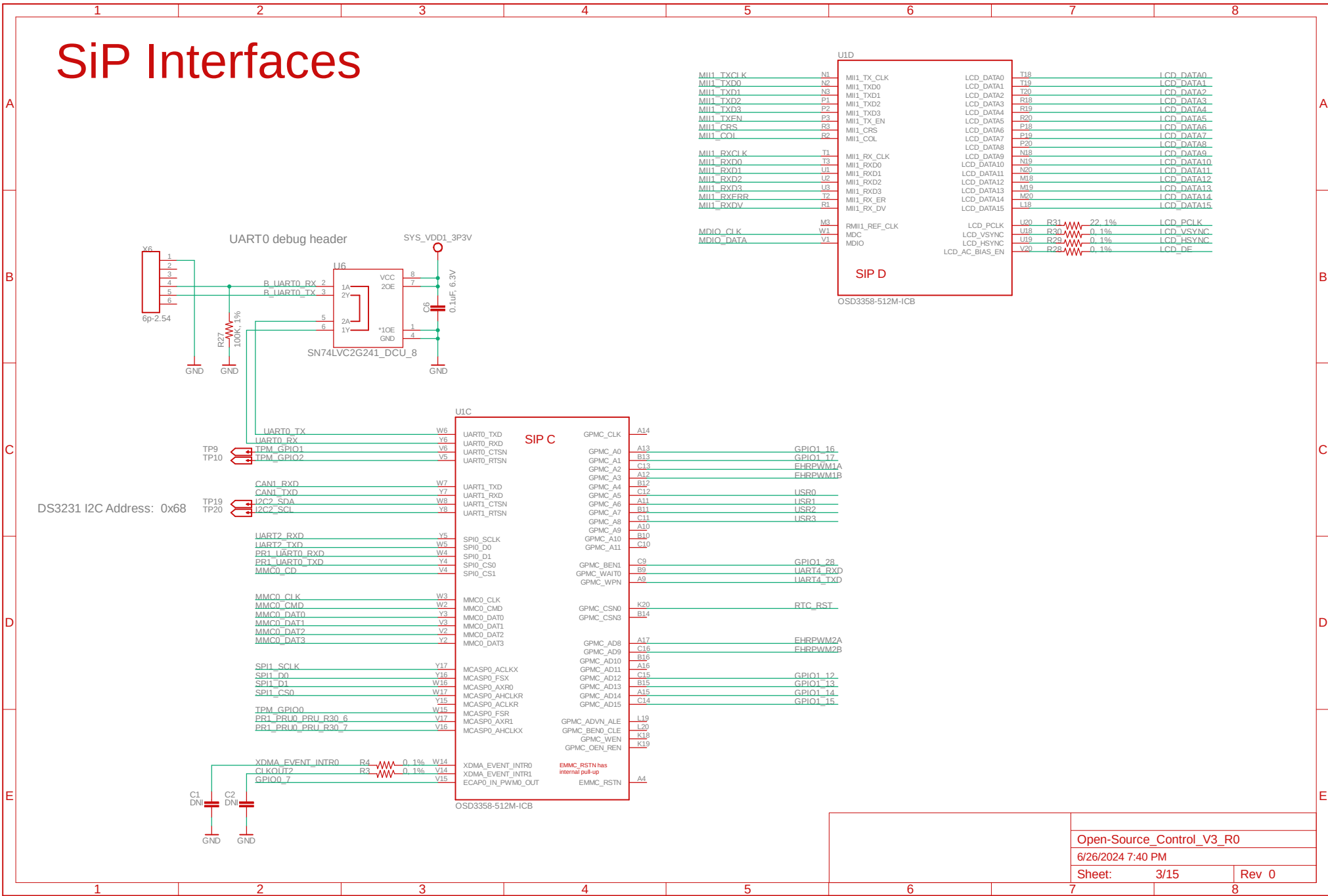
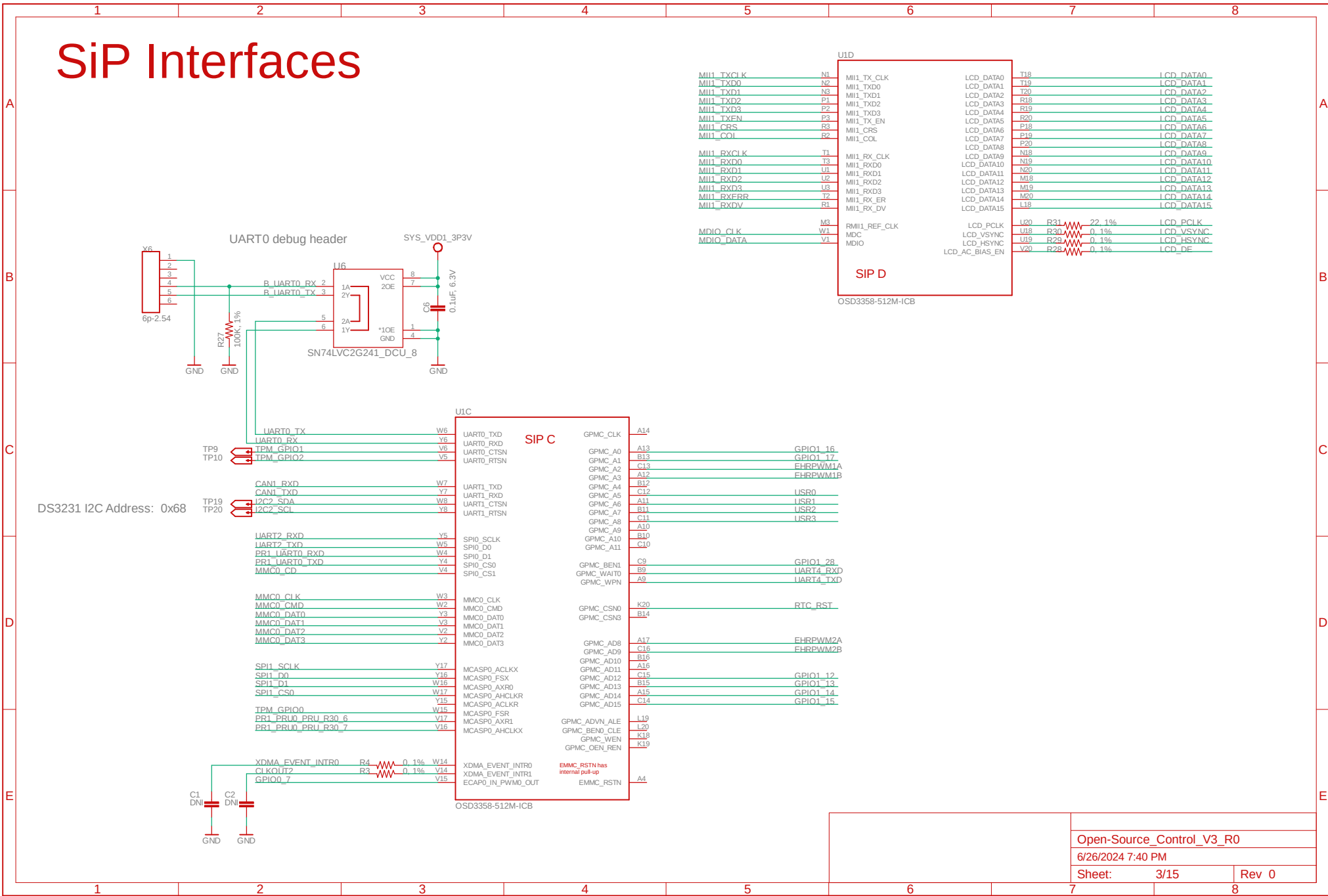
SYS_VDD1_3P3V is a 3.3V output of the OSD3358-512M-ICB. A divide by 2 resistor divider is used to ensure that the PMIC_MUX_IN voltage does not exceed 1.8V. It is not necessary to monitor the TL5209 LDO output and this can be removed if desired.

RTC_KALDO_ENN is grounded thru a 10K ohm resistor so that the internal RTC LDO is enabled and CAP_VDD_RTC does not need to be connected to VDD_CORE.

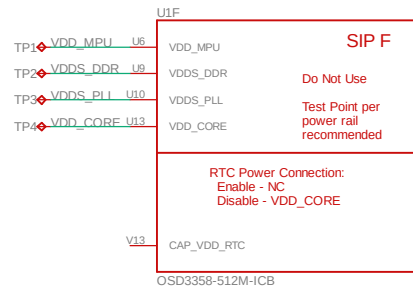
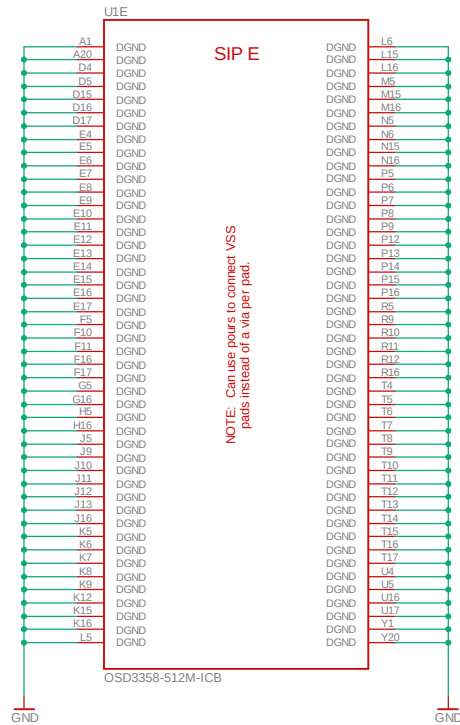
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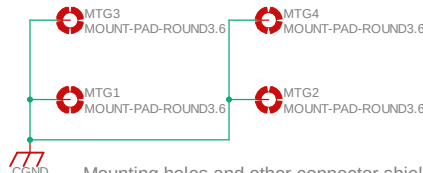
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SiP GND & Misc



Mounting Holes

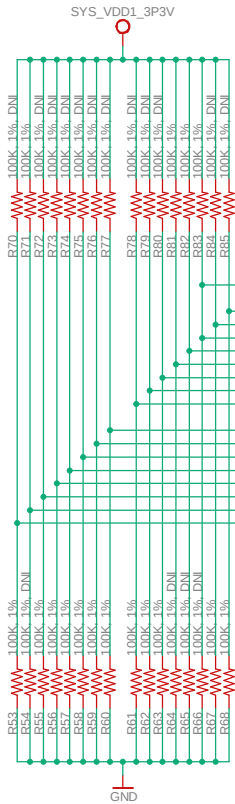


Mounting holes and other connector shields are part of a ground ring, CGND. This ring is connected to ground via a resistor on Page 1.

Fiducials



Boot configuration



SYSBOOT[15:0] functionality can be found in the "SYSBOOT Configuration Pins" section of the AM335x TRM (spruh73)

SYSBOOT[15:0] = 0x401C (default)
- Boot Order: MMC1, MMC0, UART0, USB0

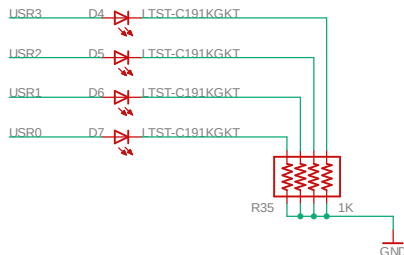
SYSBOOT[15:0] = 0x4018 (SD boot)
- Boot Order: SPI0, MMC0, USB0, UART0

Configuration:
- 24 MHz Crystal (SYSBOOT[14:15] = 01b)
- CLKOUT1 disabled (SYSBOOT[5] = 0b)

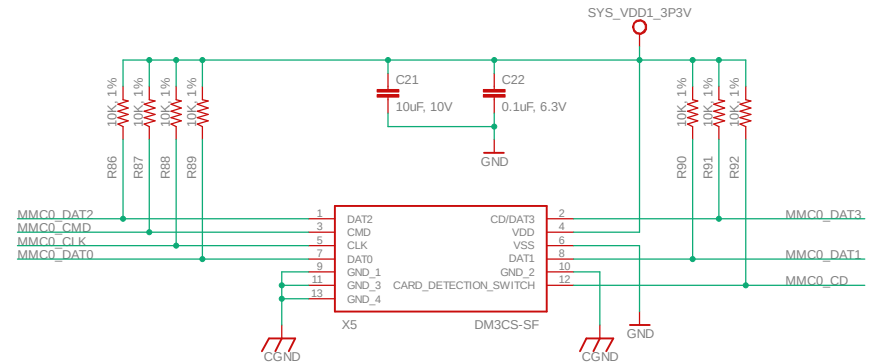
Half of these resistors, i.e. the ones marked with 'DNI', can be removed. Only 16 resistors are needed in order to select the default boot mode. The button above is used to choose an optional SD card boot mode.

BOOT Select Jumper:
On for SDC Boot

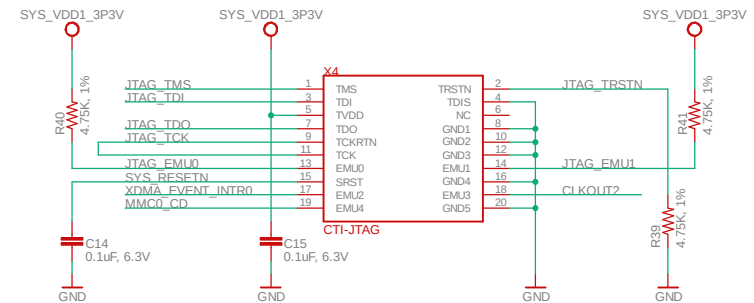
User LEDs



Micro SD card slot



JTAG Header



Only connect EMU2, EMU3 and EMU4 if you plan to use advanced JTAG features (HS-RTDX, Core Trace, System Trace, etc) of higher end debuggers:

- http://processors.wiki.ti.com/index.php/JTAG_Connectors
- http://processors.wiki.ti.com/index.php/XDS_Target_Connection_Guide

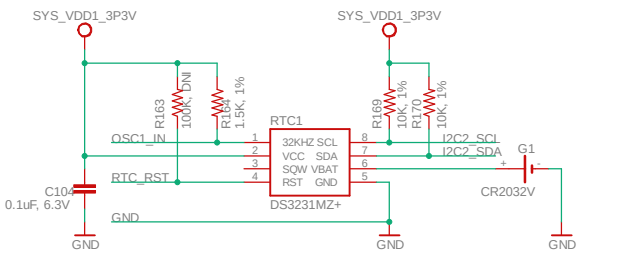
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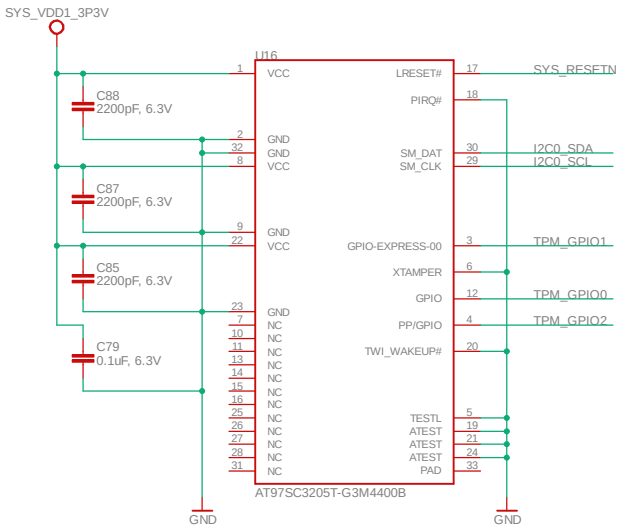
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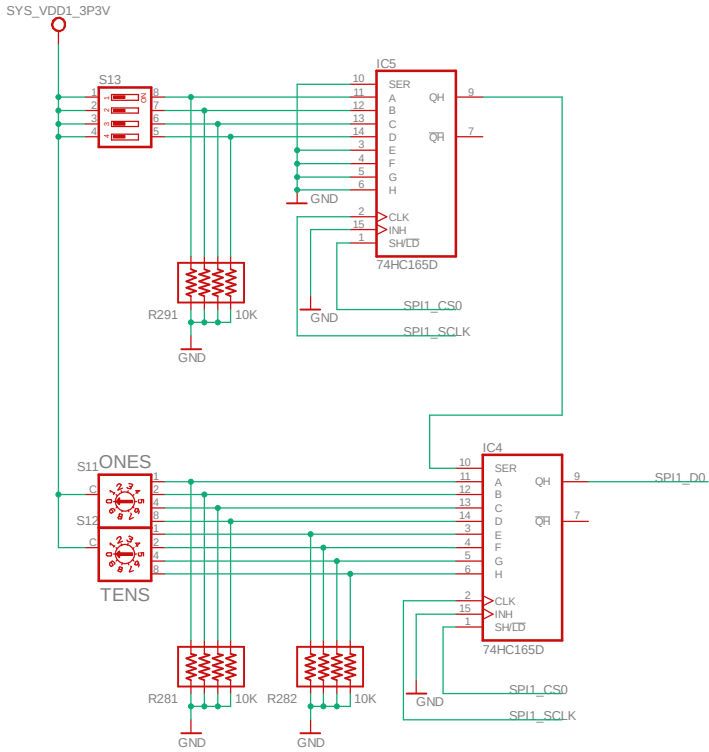
External Real Time Clk



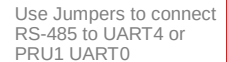
TPM



User Config Switches

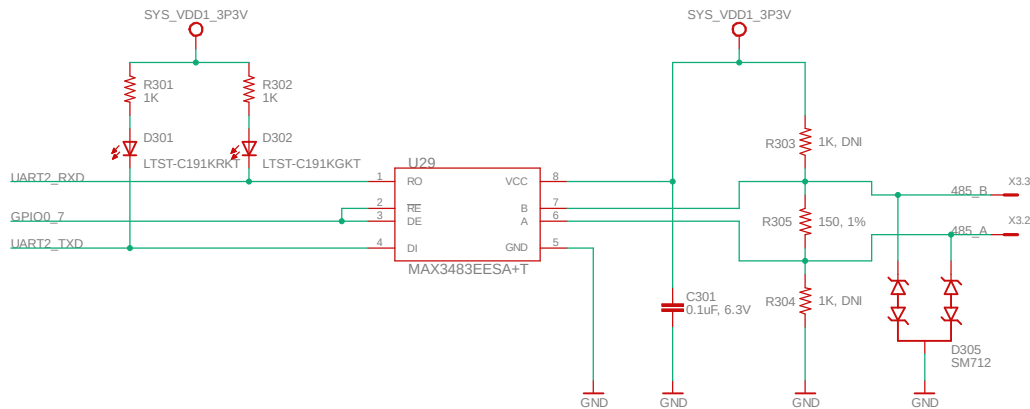


E

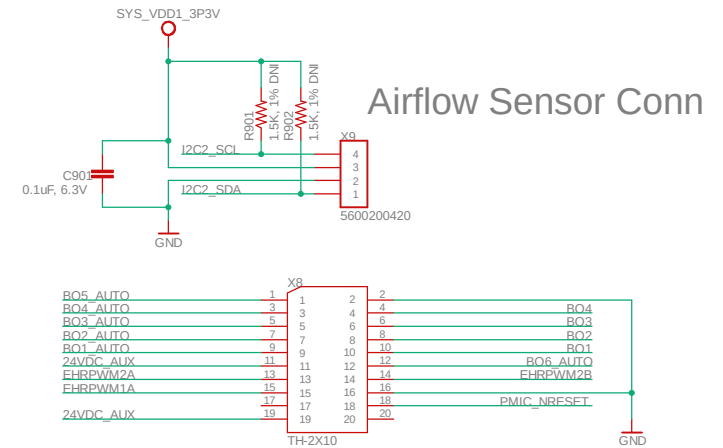


10/100BASE-T Ethernet

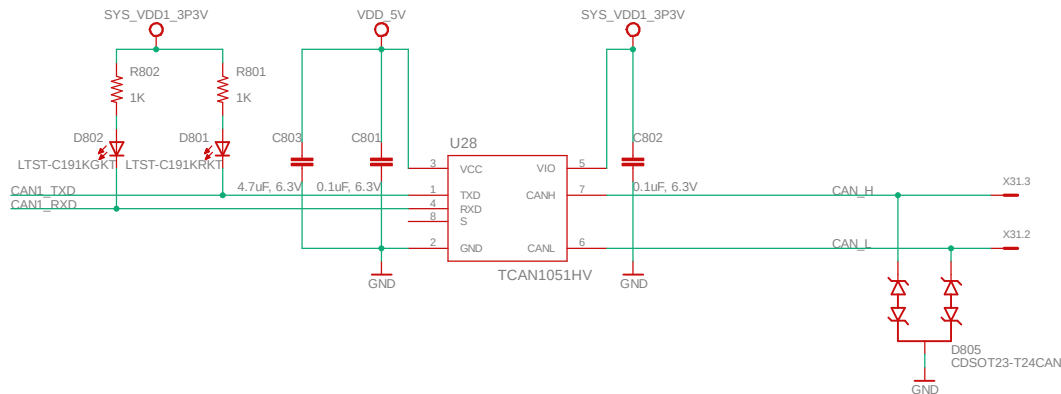
Local Network RS-485



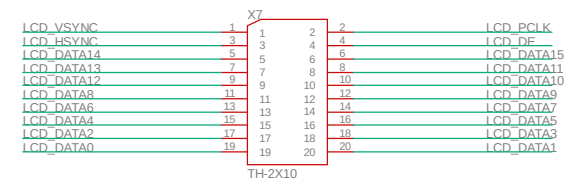
Modular IO Connections



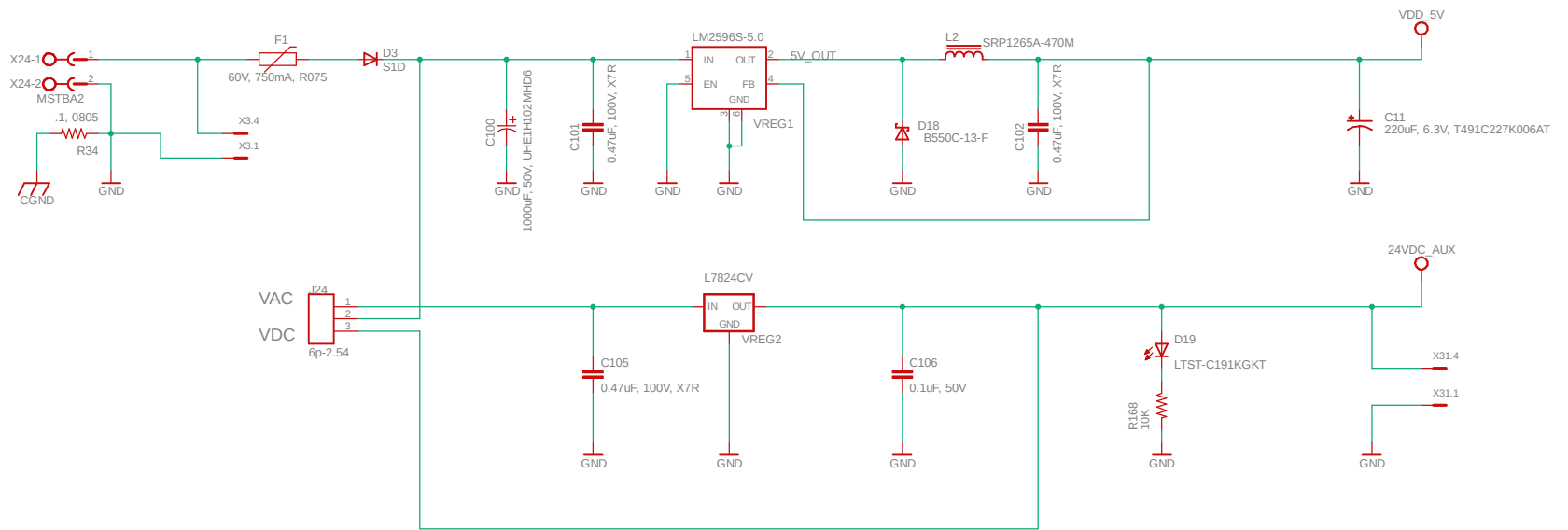
CAN Interface



LCD Header



Power Supply

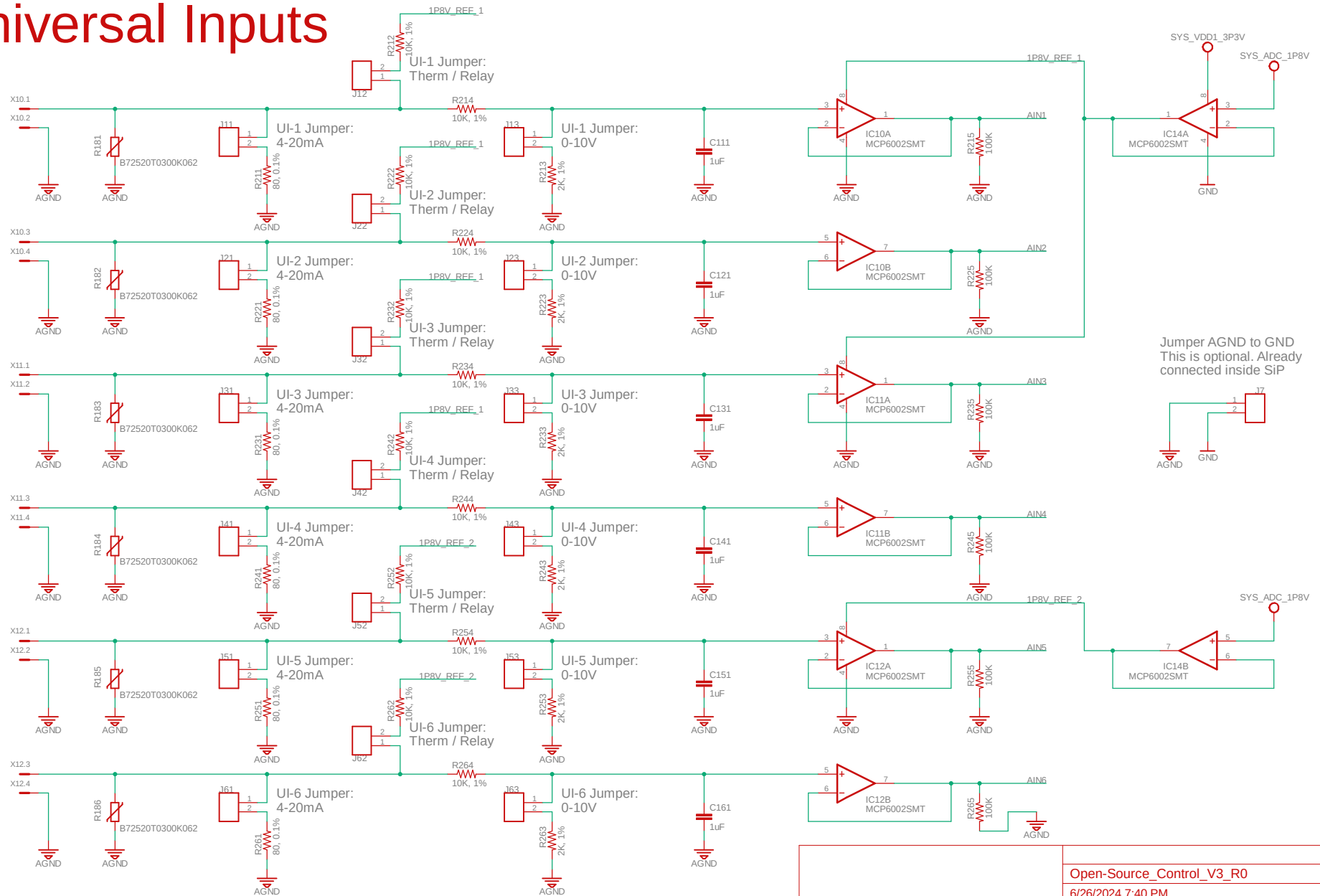


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Universal Inputs

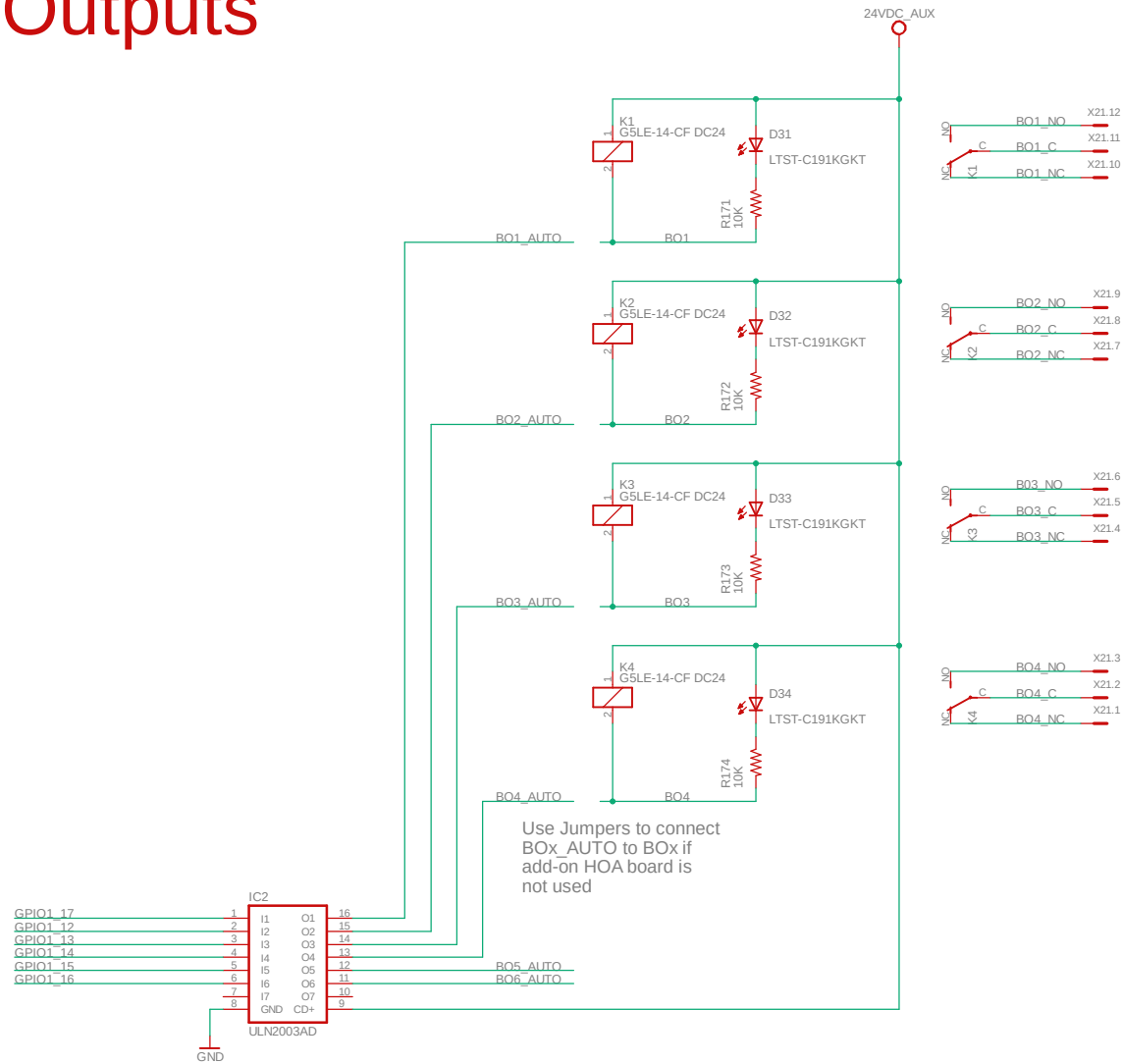


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Relay Outputs



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1	2	3	4	5	6	7	8	
A								A
B								B
C								C
D								D
E								E
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1	2	3	4	5	6	7	8	

1	2	3	4	5	6	7	8
A							A
B							B
C							C
D							D
E							E
1	2	3	4	5	6	7	8

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	1	2	3	4	5	6	7	8
A	<div>Notes</div> <div>Rev 0: 1) New Modular Design</div>							
B								
C								
D								
E								
	1	2	3	4	5	6	7	8